LEADING AT THE EDGE
TECHNOLOGY AND MANUFACTURING DAY
IDM ADVANTAGE

DR. MURTHY RENDUCHINTALA
President - Client, IoT Businesses & Systems Architecture Group
Intel Technology and Manufacturing Day 2017 occurs during Intel's “Quiet Period,” before Intel announces its 2017 first quarter financial and operating results. Therefore, presenters will not be addressing first quarter information during this year's program.

Statements in this presentation that refer to forecasts, future plans and expectations are forward-looking statements that involve a number of risks and uncertainties. Words such as “anticipates,” “expects,” “intends,” “goals,” “plans,” “believes,” “seeks,” “estimates,” “continues,” “may,” “will,” “would,” “should,” “could,” and variations of such words and similar expressions are intended to identify such forward-looking statements. Statements that refer to or are based on projections, uncertain events or assumptions also identify forward-looking statements. Such statements are based on management's expectations as of March 28, 2017, and involve many risks and uncertainties that could cause actual results to differ materially from those expressed or implied in these forward-looking statements. Important factors that could cause actual results to differ materially from the company's expectations are set forth in Intel's earnings release dated January 26, 2017, which is included as an exhibit to Intel's Form 8-K furnished to the SEC on such date. Additional information regarding these and other factors that could affect Intel's results is included in Intel's SEC filings, including the company's most recent reports on Forms 10-K, 10-Q and 8-K reports may be obtained by visiting our Investor Relations website at www.intc.com or the SEC's website at www.sec.gov.
WAVES OF INNOVATION

PREDICTABLE CADENCE

CO-OPTIMIZED PROCESS & ARCHITECTURE

COMPELLING IMPROVEMENTS
Annual Product Cadence Example

2H '15
6th Gen

6th Gen (Skylake): i7-6600U, PL1=15W TDP, 2C4T, Turbo up to 3.4GHz, Memory: 2x4GB DDR4-2133, vs.

7th Gen (Kaby Lake): i7-7600U, PL1=15W TDP, 2C4T, Turbo up to 3.9GHz, Memory: 2x4GB DDR4-2133, vs.

8th Gen (Kaby Lake U42): PL1=15W and PL2=44W TDP, 4C8T, Turbo up to 4.0GHz. Additional config details: Storage: Intel SSD, Display Resolution: 1920x1080, OS: Windows® 10 64-bit. Note: Kaby Lake U42 performance estimates are Pre-Silicon, apply to top bin, and are subject to change. Pre-Sil projections have +/- 7% margin of error.

Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests, such as SYSmark and MobileMark, are measured using specific computer systems, components, software, operations and functions. Any change to any of these factors may cause the results to vary. You should consult other information and performance tests to assist you in fully evaluating your contemplated purchases, including the performance of that product when combined with other products. For more information go to www.intel.com/benchmarks.
IP IN MULTIPLE TECHNOLOGIES

- CPU
- GRAPHICS
- MODEM
- NETWORKING
- IO
- PERIPHERALS

- Waves of 10 nm
- Waves of 14 nm
- Waves of 22 nm
14 NM
RICH PORTFOLIO OF PRODUCTS

NETWORKING
2018

MODEM
EOY '17

PCH
1H 18

FPGA
STRATIX 10 NOW

ATOMIC

CORE
inside

XENON
inside

XENON PHI
inside

5G

LTE

TECHNOLOGY AND MANUFACTURING DAY
TRADITIONAL MONOLITHIC DESIGN
“MIX AND MATCH”
HETEROGENEOUS DESIGN
CO-OPTIMIZED PROCESS & ARCHITECTURE + ANNUAL CADENCE + FOUNDRY = INTEL IDM ADVANTAGE